

## ULN2003A Darlington Transistor (NPN)

### 1 Introduction

ULN2003A is a high voltage, high current Darlington transistor array. Each device consists of seven NPN Darlington pairs that can be output independently. These Darlington pairs have common emitter poles that support high voltage output with a common cathode clamp diode for switching inductive loads. The input and output of the clamp diode are relatively fixed to simplify the layout of the printed circuit board. The collector current of a single Darlington pair is rated at 500mA, and parallel Darlington pairs provide a higher current.

Each Darlington pair of ULN2003A devices has a 2.7kΩ series base resistance that works directly with TTL or CMOS devices. This device is often used to drive a variety of loads, such as DC engine, LED display light, high power cache and general logic circuits such as TTL, 5V CMOS, etc.

### 2 Available Package

| PART NUMBER | PACKAGE |
|-------------|---------|
| ULN2003A    | SOP16   |

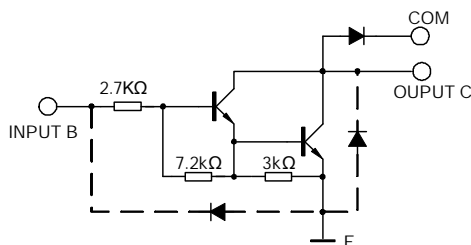


Figure 2-1. Functional Block Diagram

### 3 Features

- 500mA rated collector current (single output)
- High voltage output: 50V
- Output clamp diode
- Compatible with all kinds of logic input
- Relay driver application

### 4 Applications

- Relay Drivers
- Hammer Drivers
- Lamp Drivers
- Line Drivers
- Logic Buffers
- Stepper Motors
- IP Camera
- HVAC Valve and LED Dot Matrix

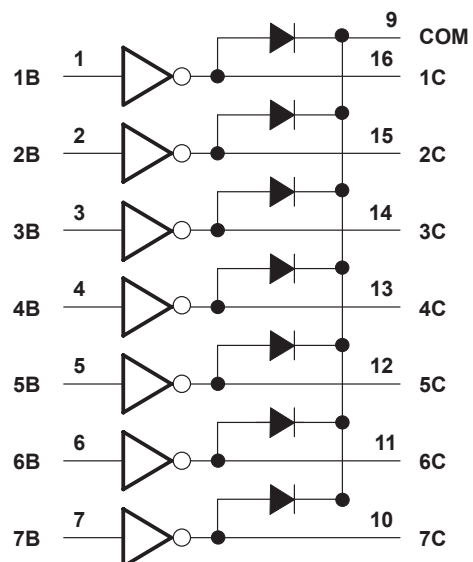


Figure 2-2. Simplified Block Diagram

## 5 Orderable Information

| MODEL | DEVICE   | PACKAGE | OP TEMP    | ECO PLAN     | MSL               | PACKING OPTION                     | SORT   |
|-------|----------|---------|------------|--------------|-------------------|------------------------------------|--------|
| -     | ULN2003A | SOP16   | -40 ~ 85°C | RoHS & Green | Level 3<br>168 HR | Tape and Reel<br>2500 Units / Reel | Active |

**Note:**

**ECO PLAN:** For the RoHS and Green certification standards of this product, please refer to the official report provided by JSCJ.

**MSL:** Moisture Sensitivity Level. Determined according to JEDEC industry standard classification.

**SORT:** Specifically defined as follows:

Active: Recommended for new products;

Customized: Products manufactured to meet the specific needs of customers;

Preview: The device has been released and has not been fully mass produced. The sample may or may not be available;

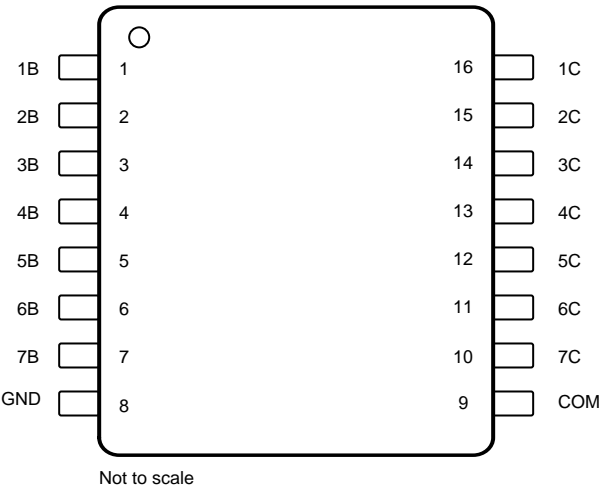
NoRD: It is not recommended to use the device for new design. The device is only produced for the needs of existing customers;

Obsolete: The device has been discontinued.

6 Pin Configuration and Marking Information

6.1 Pin Configuration and Function

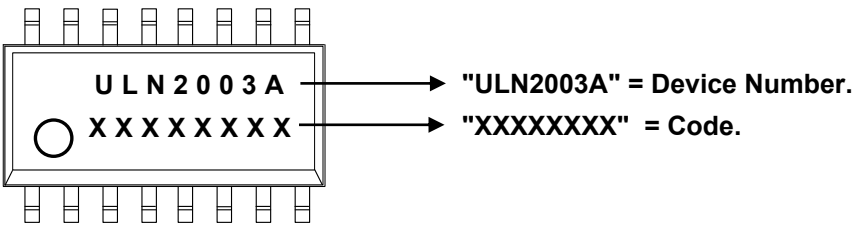
Figure 6-1. SOP16 Package Top View



Pin Functions

| PIN  |     | TYPE | DESCRIPTION   |
|------|-----|------|---|
| NAME | NO. |      |   |
| 1B   | 1   | I    | Channel 1 through 7 Darlington base input                             |
| 2B   | 2   |      |   |
| 3B   | 3   |      |   |
| 4B   | 4   |      |   |
| 5B   | 5   |      |   |
| 6B   | 6   |      |   |
| 7B   | 7   |      |   |
| 1C   | 16  | O    | Channel 1 through 7 Darlington collector output                       |
| 2C   | 15  |      |   |
| 3C   | 14  |      |   |
| 4C   | 13  |      |   |
| 5C   | 12  |      |   |
| 6C   | 11  |      |   |
| 7C   | 10  |      |   |
| GND  | 8   | —    | Common emitter shared by all channels (typically tied to ground)      |
| COM  | 9   | I/O  | Common cathode node for flyback diodes (required for inductive loads) |

6.2 Marking Information



## 7 Specifications

### 7.1 Absolute Maximum Ratings

at 25°C free-air temperature (unless otherwise specified)<sup>(1)</sup>

| CHARACTERISTIC                 |          |       | SYMBOL             | VALUE                             | UNIT |
|--------------------------------|----------|-------|--------------------|-----------------------------------|------|
| Output voltage <sup>(2)</sup>  |          |       | V <sub>OUT</sub>   | 50                                | V    |
| Input voltage <sup>(2)</sup>   |          |       | V <sub>IN</sub>    | 30                                | V    |
| Collector current (continuous) |          |       | I <sub>C</sub>     | 500                               | mA   |
| Base current (continuous)      |          |       | I <sub>B</sub>     | 25                                | mA   |
| Maximum power dissipation      | ULN2003A | SOP16 | P <sub>D MAX</sub> | Internally Limited <sup>(3)</sup> | W    |
| Maximum junction temperature   |          |       | T <sub>J MAX</sub> | 150                               | °C   |
| Storage temperature            |          |       | T <sub>stg</sub>   | -55 ~ 150                         | °C   |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to network ground terminal.

(3) Refer to *Thermal Information* for details.

### 7.2 Recommended Operating Conditions

| PARAMETER                      | SYMBOL         | MIN. | NOM. | MAX. | UNIT |
|--------------------------------|----------------|------|------|------|------|
| Operating junction temperature | T <sub>J</sub> | -40  | -    | 125  | °C   |
| Operating ambient temperature  | T <sub>A</sub> | -40  | -    | 85   | °C   |

### 7.3 ESD Ratings

| ESD RATINGS                            |                  | SYMBOL               | VALUE | UNIT |
|--|------------------|----------------------|-------|------|
| Electrostatic discharge <sup>(4)</sup> | Human body model | V <sub>ESD-HBM</sub> | 2000  | V    |
|  | Machine model    | V <sub>ESD-MM</sub>  | 200   |      |

(4) ESD testing is conducted in accordance with the relevant specifications formulated by the Joint Electronic Equipment Engineering Commission (JEDEC). The human body model (HBM) electrostatic discharge test is based on the JESD22-114D test standard, using a 100pF capacitor and discharging to each pin of the device through a resistance of 1.5kΩ. The electrostatic discharge test in mechanical model (MM) is based on the JESD22-A115-A test standard and uses a 200pF capacitor to discharge directly to each pin of the device.

## 7 Specifications

### 7.4 Thermal Information

| THERMAL METRIC   |                     | SYMBOL              | SOP16 | UNIT                 |
|--|---------------------|---------------------|-------|----------------------|
| Thermal resistance   | Junction-to-ambient | $R_{\theta JA}$     | 100.0 | $^{\circ}\text{C/W}$ |
|  | Junction-to-case    | $R_{\theta JC}$     | 20.0  |                      |
| Reference maximum power dissipation for continuous operation |                     | $P_{D \text{ Ref}}$ | 1.00  | W                    |

### 7.5 Electrical Characteristics

at 25°C free-air temperature (unless otherwise specified)

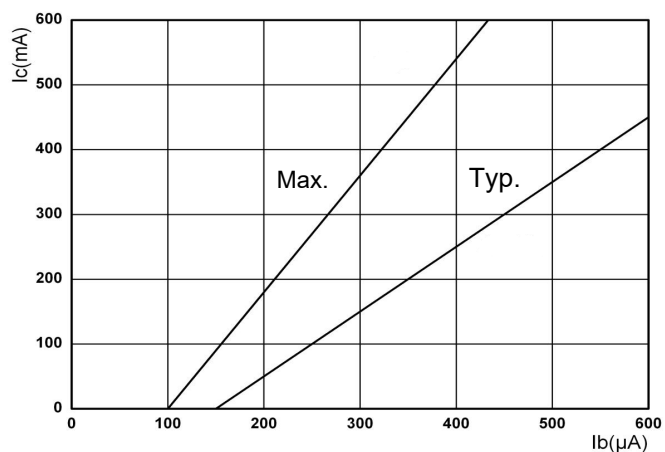
| CHARACTERISTIC                       | SYMBOL        | TEST CONDITIONS                             | FIGURES | MIN. | TYP. <sup>(6)</sup> | MAX. | UNIT          |
|--------------------------------------|---------------|---|---------|------|---------------------|------|---------------|
| Collector cutoff current             | $I_{CEX}$     | $V_{CE} = 50\text{V}$                       | 1a      | -    | -                   | 50.0 | $\mu\text{A}$ |
| Collector-emitter saturation voltage | $V_{CE(SAT)}$ | $I_C = 100\text{mA}, I_B = 250\mu\text{A}$  | 2       | -    | 0.9                 | 1.1  | V             |
|                                      |               | $I_C = 200\text{mA}, I_B = 350\mu\text{A}$  |         | -    | 1.1                 | 1.3  |               |
|                                      |               | $I_C = 350\text{mA}, I_B = 500\mu\text{A}$  |         | -    | 1.3                 | 1.6  |               |
| Input current (ON)                   | $I_{IN(ON)}$  | $V_{IN} = 3.85\text{V}$                     | 3       | -    | 0.93                | 1.35 | mA            |
| Input voltage (ON)                   | $V_{IN(ON)}$  | $V_{CE} = 2.0\text{V}, I_C = 200\text{mA}$  | 5       | -    | -                   | 2.4  | V             |
|                                      |               | $V_{CE} = 2.0\text{V}, I_C = 250\text{mA}$  |         | -    | -                   | 2.7  |               |
|                                      |               | $V_{CE} = 2.0\text{V}, I_C = 300\text{mA}$  |         | -    | -                   | 3.0  |               |
| Clamp reverse current                | $I_R$         | $V_R = 50\text{V}$                          | 6       | -4.0 | -                   | 50   | $\mu\text{A}$ |
| Clamp forward voltage                | $V_F$         | $I_F = 350\text{mA}$                        | 7       | -    | 1.7                 | 2.0  | V             |
| Output leakage current               | $I_{CEX-1V}$  | $V_{CE} = 50\text{V}, V_{IN} = 1.0\text{V}$ | 1b      | -5.0 | -                   | 80   | $\mu\text{A}$ |

**Note:**

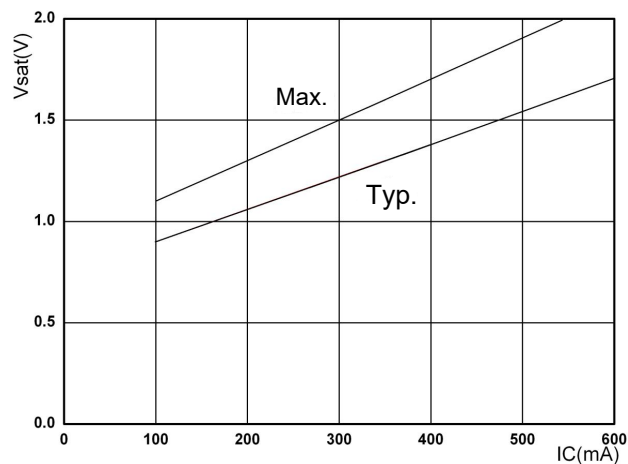
(6) Typical numbers are at 25°C and represent the most likely norm.

### 7.6 Typical Characteristics

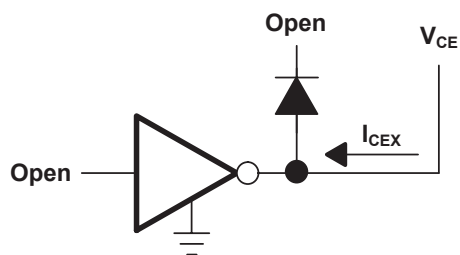
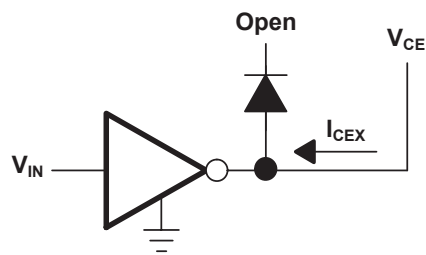
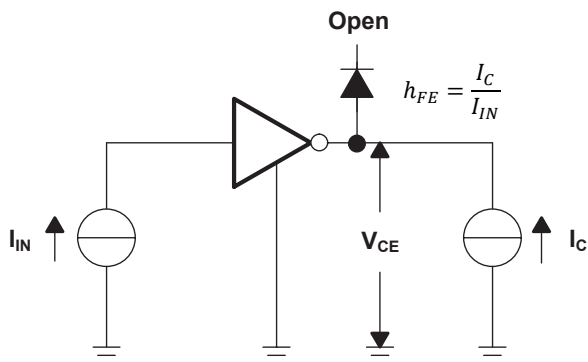
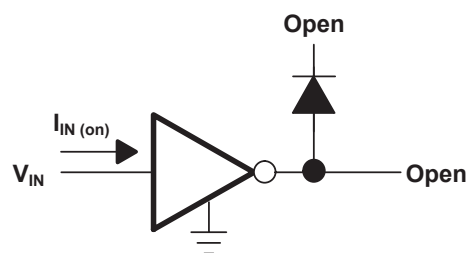
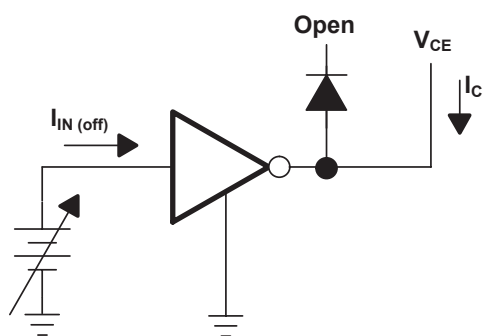
Output Current vs. Input Current



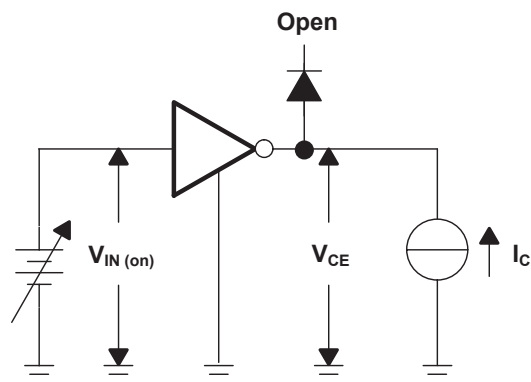
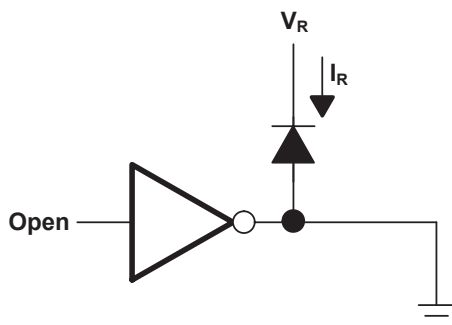
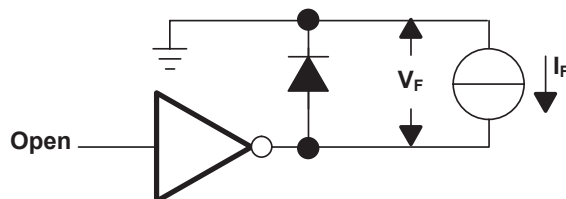
Saturation Voltage vs. Output Voltage



## 8 Parameter Measurement Information

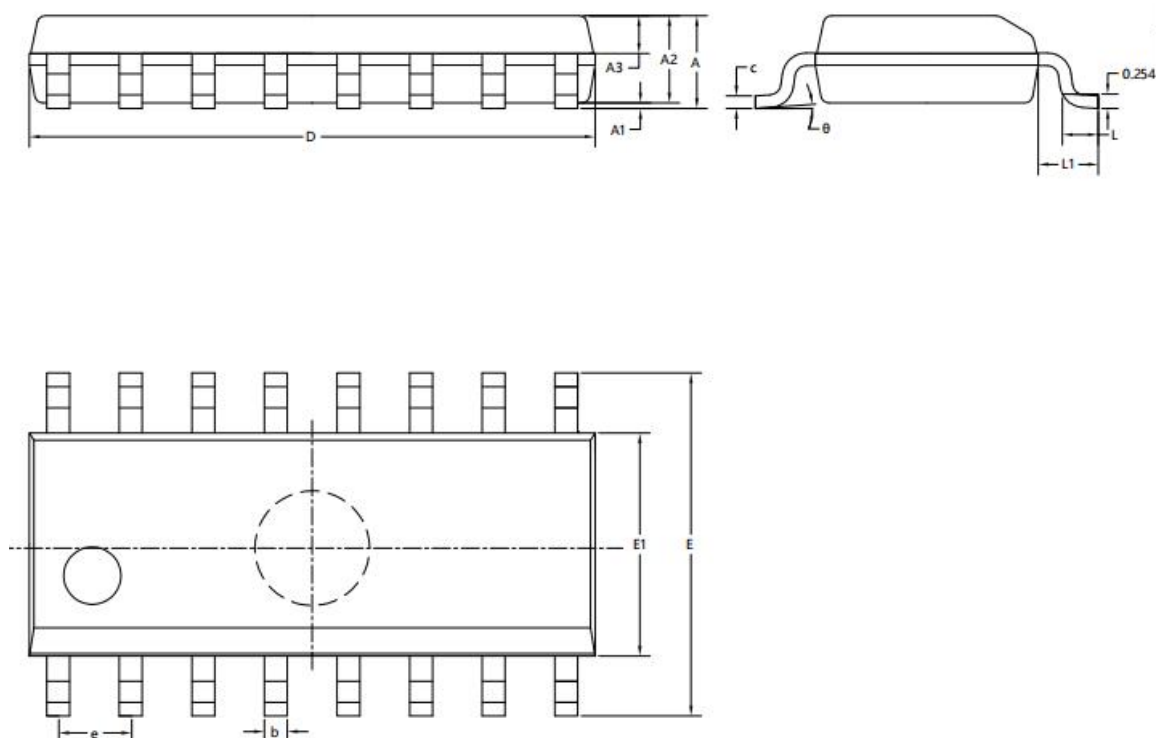
Figure 1a.  $I_{CEX}$  Test CircuitFigure 1b.  $I_{CEX}$  Test CircuitFigure 2.  $h_{FE}$ ,  $V_{CE(SAT)}$  Test CircuitFigure 3.  $I_{IN}$  Test Circuit

$I_{IN}$  is fixed when used to measure  $V_{CE}$  and variable when used to measure  $h_{FE}$

Figure 4.  $I_{IN(off)}$  Test CircuitFigure 5.  $V_{IN(on)}$  Test CircuitFigure 6.  $I_R$  Test CircuitFigure 7.  $V_F$  Test Circuit

## 9 Mechanical Information

### SOP16 Package



| SYMBOL | DIMENSIONS IN MILLIMETERS |       |        | DIMENSIONS IN INCHES |       |       |
|--------|---------------------------|-------|--------|----------------------|-------|-------|
|        | MIN                       | NOM   | MAX    | MIN                  | NOM   | MAX   |
| A      | 1.500                     | 1.600 | 1.700  | 0.059                | 0.063 | 0.068 |
| A1     | 0.100                     | 0.150 | 0.250  | 0.004                | 0.006 | 0.010 |
| A2     | 1.400                     | 1.450 | 1.500  | 0.055                | 0.057 | 0.059 |
| A3     | 0.600                     | 0.650 | 0.700  | 0.024                | 0.026 | 0.028 |
| b      | 0.300                     | 0.400 | 0.500  | 0.012                | 0.016 | 0.020 |
| c      | 0.150                     | 0.200 | 0.250  | 0.006                | 0.008 | 0.010 |
| D      | 9.800                     | 9.900 | 10.000 | 0.386                | 0.390 | 0.394 |
| E      | 5.800                     | 6.000 | 6.200  | 0.228                | 0.236 | 0.244 |
| E1     | 3.850                     | 3.900 | 3.950  | 0.152                | 0.154 | 0.156 |
| e      | 1.270 Bsc.                |       |        | 0.050 Bsc.           |       |       |
| L      | 0.500                     | 0.600 | 0.700  | 0.020                | 0.024 | 0.028 |
| L1     | 1.050 Bsc.                |       |        | 0.041 Bsc.           |       |       |
| Θ      | 0°                        | 4°    | 8°     | 0°                   | 4°    | 8°    |

## 10 Notes and Revision History

### 10.1 Associated Product Family and Others

To view other products of the same type or IC products of other types, please click the official website of JSCJ -- <https://www.jscj-elec.com> for more details.

### 10.2 Notes

#### Electrostatic Discharge Caution



This IC may be damaged by ESD. Relevant personnel shall comply with correct installation and use specifications to avoid ESD damage to the IC. If appropriate measures are not taken to prevent ESD damage, the hazards caused by ESD include but are not limited to degradation of integrated circuit performance or complete damage of integrated circuit. For some precision integrated circuits, a very small parameter change may cause the whole device to be inconsistent with its published specifications.

### 10.3 Revision History

**January, 2023: changed from rev - 1.3 to rev - 1.4:**

- Page 3, Marking Information, corrected errors in marking schematic diagram;
- Page 5, Typical Characteristics, fixed errors in curve 1 names.

**October, 2023: changed from rev -1.2 to rev - 1.3:**

- Page 4, Specifications, added ESD ratings;
- Page 5, Thermal Information,  $R_{\theta JA}$  changed from 75.2 to 100,  $P_{D REF}$  changed from 1.33 to 1.00, added  $R_{\theta JC}$ ;
- Page 8, Notes, removed the notes of the thermal metric.

**April, 2023: changed from rev - 1.1 to rev - 1.2:**

- Page 2, Orderable Information, "OP TEMP" changed from "-20 ~ 85°C" to "-40 ~ 85°C";
- Page 4, Recommend Operating Condition, " $T_A$ " changed from "-20 ~ 85°C" to "-40 ~ 85°C".

**January, 2023: changed from rev - 1.0 to rev - 1.1:**

- Added the part "Orderable Information".
- Page 4, Absolute Maximum Ratings, Collector current changed from "(continuous)" to "(peak)".

**August, 2022: released ULN2003A rev - 1.0.**

# DISCLAIMER

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